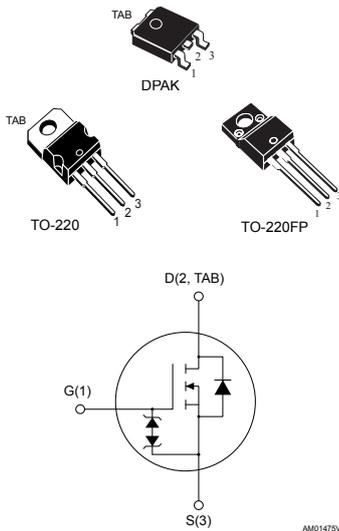


## N-channel 900 V, 3.6 $\Omega$ typ., 3 A SuperMESH™ Power MOSFETs in DPAK, TO-220 and TO-220FP packages



### Features

Order code	$V_{DS}$	$R_{DS(on)}$ max.	$I_D$	Package
STD3NK90ZT4	900 V	4.8 $\Omega$	3 A	DPAK
STP3NK90Z				TO-220
STP3NK90ZFP				TO-220FP

- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitance
- Zener-protected

### Applications

- Switching applications

### Description

These high-voltage devices are Zener-protected N-channel Power MOSFETs developed using the SuperMESH™ technology by STMicroelectronics, an optimization of the well-established PowerMESH™. In addition to a significant reduction in on-resistance, these devices are designed to ensure a high level of dv/dt capability for the most demanding applications.

#### Product status link

[STD3NK90ZT4](#)
[STP3NK90Z](#)
[STP3NK90ZFP](#)

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value		Unit
		DPAK, TO-220	TO-220FP	
$V_{DS}$	Drain-source voltage	900		V
$V_{GS}$	Gate-source voltage	± 30		V
$I_D$	Drain current (continuous) at $T_C = 25\text{ °C}$	3	3 <sup>(1)</sup>	A
$I_D$	Drain current (continuous) at $T_C = 100\text{ °C}$	1.89	1.89 <sup>(1)</sup>	A
$I_{DM}$ <sup>(2)</sup>	Drain current (pulsed)	12	12 <sup>(1)</sup>	A
$P_{TOT}$	Total dissipation at $T_C = 25\text{ °C}$	90	25	W
ESD	Gate-source human body model ( $R = 1,5\text{ k}\Omega$ , $C = 100\text{ pF}$ )	4		kV
$dv/dt$ <sup>(3)</sup>	Peak diode recovery voltage slope	4.5		V/ns
$V_{ISO}$	Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t = 1\text{ s}$ ; $T_C = 25\text{ °C}$ )		2.5	kV
$T_j$	Operating junction temperature range	-55 to 150		°C
$T_{stg}$	Storage temperature range			

- Limited by maximum junction temperature.
- Pulse width limited by safe operating area.
- $I_{SD} \leq 3\text{ A}$ ,  $di/dt \leq 200\text{ A}/\mu\text{s}$ ,  $V_{DS(peak)} \leq V_{(BR)DSS}$ ,  $V_{DD} = 80\% V_{(BR)DSS}$ .

**Table 2. Thermal data**

Symbol	Parameter	Value			Unit
		DPAK	TO-220	TO-220FP	
$R_{thj-case}$	Thermal resistance junction-case	1.38		5	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient		62.5		
$R_{thj-pcb}$ <sup>(1)</sup>	Thermal resistance junction-pcb	50			

- When mounted on 1inch<sup>2</sup> FR-4, 2 Oz copper board.

**Table 3. Avalanche characteristics**

Symbol	Parameter	Value	Unit
$I_{AR}$ <sup>(1)</sup>	Avalanche current, repetitive or not-repetitive	3	A
$E_{AS}$ <sup>(2)</sup>	Single pulse avalanche energy	180	mJ

- Pulse width limited by  $T_{jmax}$ .
- Starting  $T_j = 25\text{ °C}$ ,  $I_D = I_{AR}$ ,  $V_{DD} = 50\text{ V}$ .

## 2 Electrical characteristics

( $T_{CASE} = 25\text{ °C}$  unless otherwise specified)

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1\text{ mA}$ , $V_{GS} = 0\text{ V}$	900			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$ , $V_{DS} = 900\text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$ , $V_{DS} = 900\text{ V}$ , $T_C = 125\text{ °C}$ <sup>(1)</sup>			50	$\mu\text{A}$
$I_{GSS}$	Gate body leakage current	$V_{DS} = 0\text{ V}$ , $V_{GS} = \pm 20\text{ V}$			$\pm 10$	$\mu\text{A}$
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 50\text{ }\mu\text{A}$	3	3.75	4.5	V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10\text{ V}$ , $I_D = 1.5\text{ A}$		3.6	4.8	$\Omega$

1. Defined by design, not subject to production test.

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 25\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	-	590	-	$\mu\text{F}$
$C_{oss}$	Output capacitance			63		
$C_{rSS}$	Reverse transfer capacitance			13		
$C_{oss\text{ eq.}}^{(1)}$	Equivalent output capacitance	$V_{DS} = 0\text{ to }720\text{ V}$ , $V_{GS} = 0\text{ V}$	-	35	-	$\mu\text{F}$
$Q_g$	Total gate charge	$V_{DD} = 720\text{ V}$ , $I_D = 3\text{ A}$ , $V_{GS} = 0\text{ to }10\text{ V}$ (see Figure 16. Test circuit for gate charge behavior)	-	22.7	-	nC
$Q_{gs}$	Gate-source charge			4.2		
$Q_{gd}$	Gate-drain charge			12		

1.  $C_{oss\text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

**Table 6. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 450\text{ V}$ , $I_D = 1.5\text{ A}$ , $R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$ (see Figure 15. Test circuit for resistive load switching times and Figure 20. Switching time waveform)	-	18	-	ns
$t_r$	Rise time			7		
$t_{d(off)}$	Turn-off delay time			45		
$t_f$	Fall time			18		

**Table 7. Source drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current		-		3	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				12	
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 3\text{ A}$ , $V_{GS} = 0\text{ V}$	-		1.6	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 3\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$	-	510		ns
$Q_{rr}$	Reverse recovery charge	$V_{DD} = 40\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$		2.2		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	(see Figure 17. Test circuit for inductive load switching and diode recovery times)		8.7		A

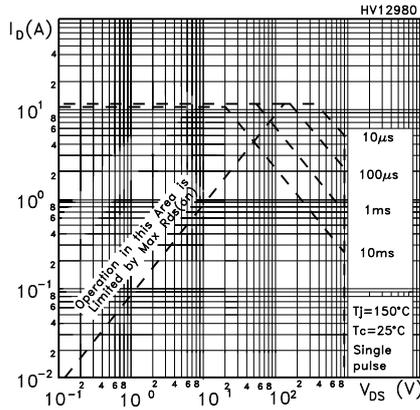
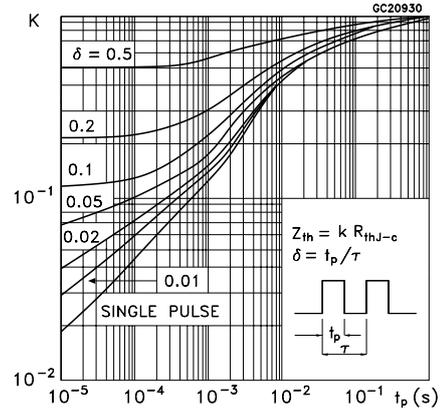
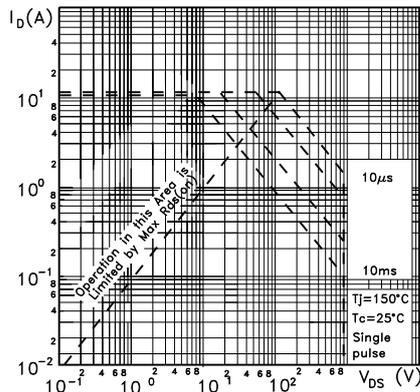
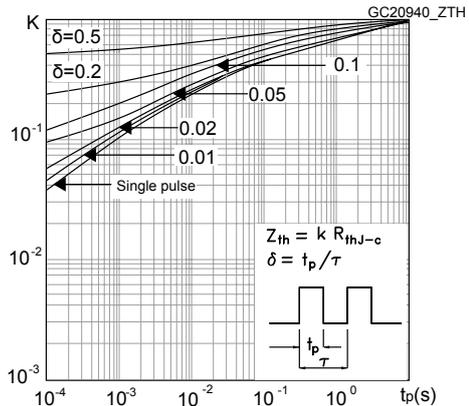
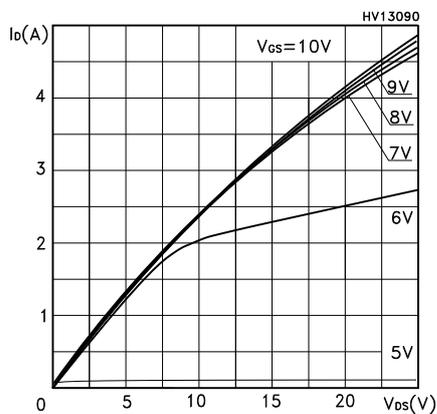
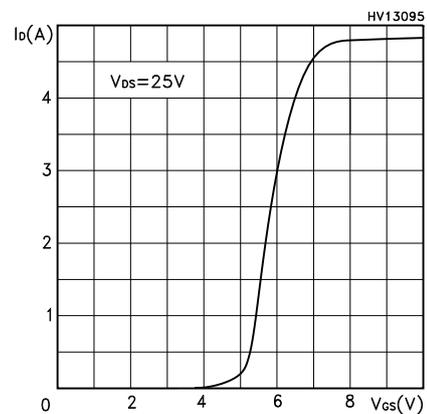
1. Pulse width limited by safe operating area.
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

**Table 8. Gate-source Zener diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1\text{ mA}$ , $I_D = 0\text{ A}$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

## 2.1 Electrical characteristics curves

**Figure 1. Safe operating area for DPAK, TO-220**

**Figure 2. Thermal impedance for DPAK, TO-220**

**Figure 3. Safe operating area for TO-220FP**

**Figure 4. Thermal impedance for TO-220FP**

**Figure 5. Output characteristics**

**Figure 6. Transfer characteristics**


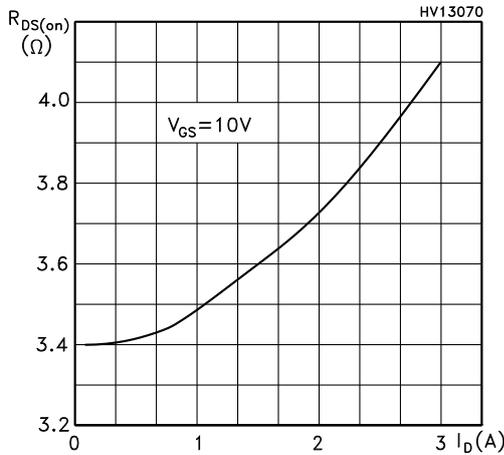
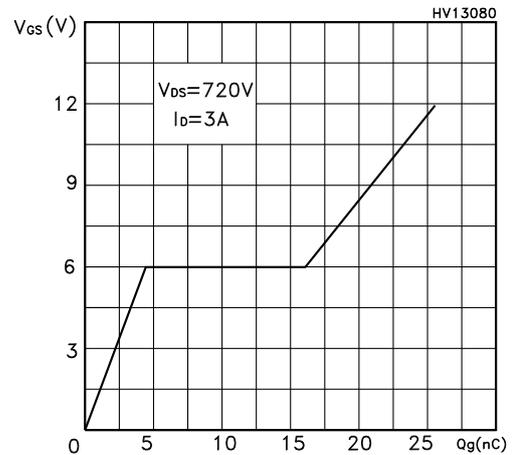
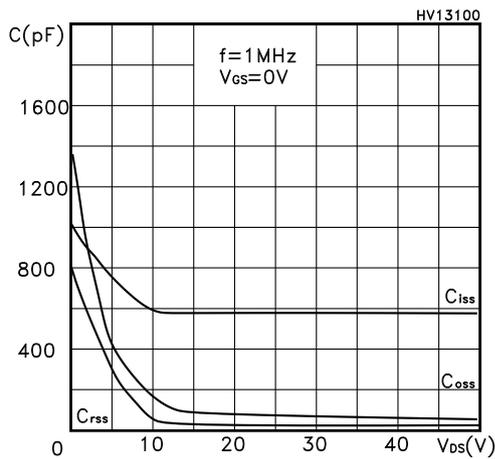
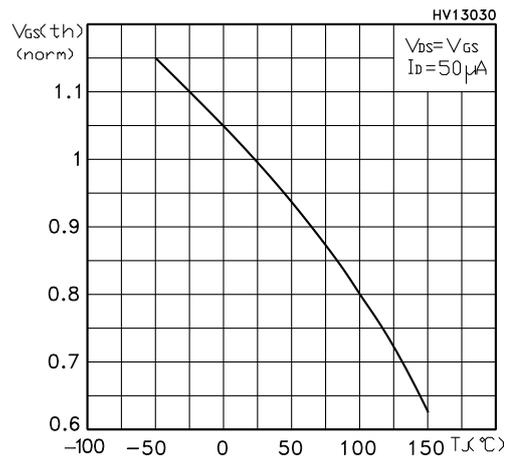
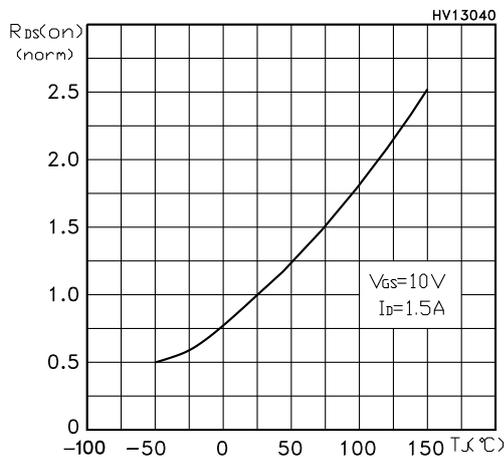
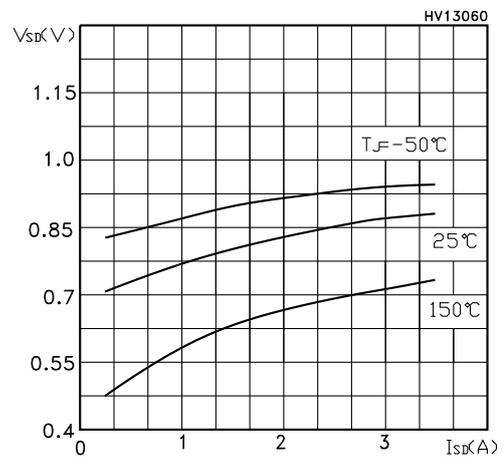
**Figure 7. Static drain-source on resistance**

**Figure 8. Gate charge vs gate-source voltage**

**Figure 9. Capacitance variations**

**Figure 10. Normalized gate threshold voltage vs temperature**

**Figure 11. Normalized on resistance vs temperature**

**Figure 12. Source-drain diode forward characteristics**


Figure 13. Maximum avalanche energy vs temperature

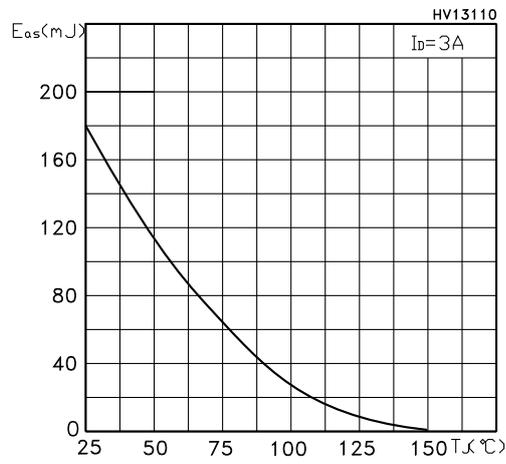
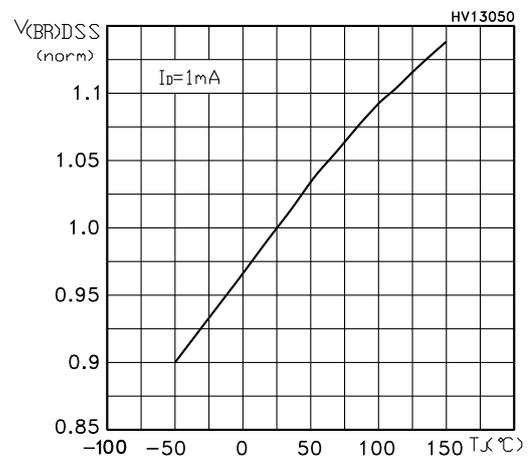
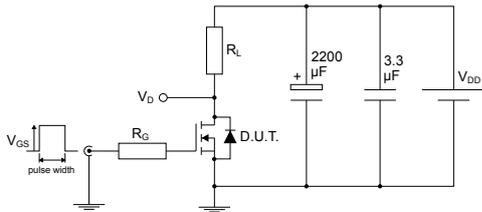


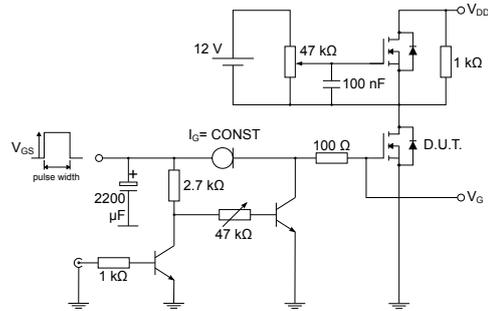
Figure 14. Normalized  $V_{(BR)DSS}$  vs temperature



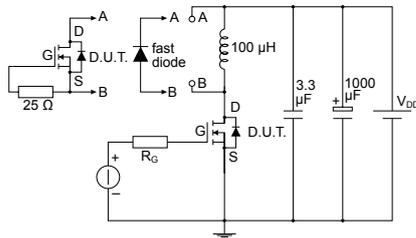
### 3 Test circuits

**Figure 15. Test circuit for resistive load switching times**


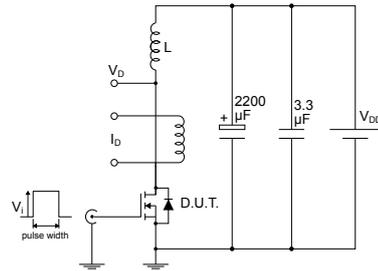
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**Figure 16. Test circuit for gate charge behavior**


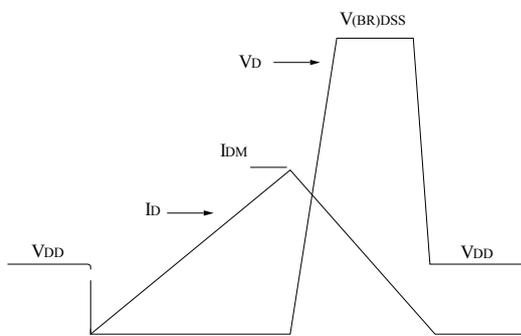
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**Figure 17. Test circuit for inductive load switching and diode recovery times**


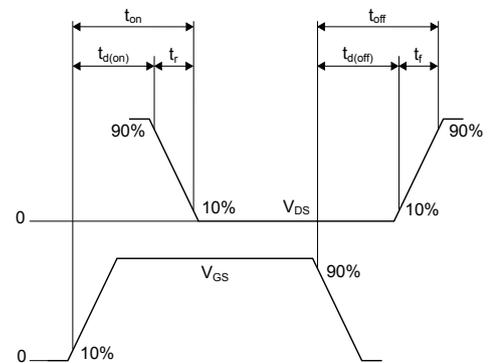
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**Figure 18. Unclamped inductive load test circuit**


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**Figure 19. Unclamped inductive waveform**


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**Figure 20. Switching time waveform**


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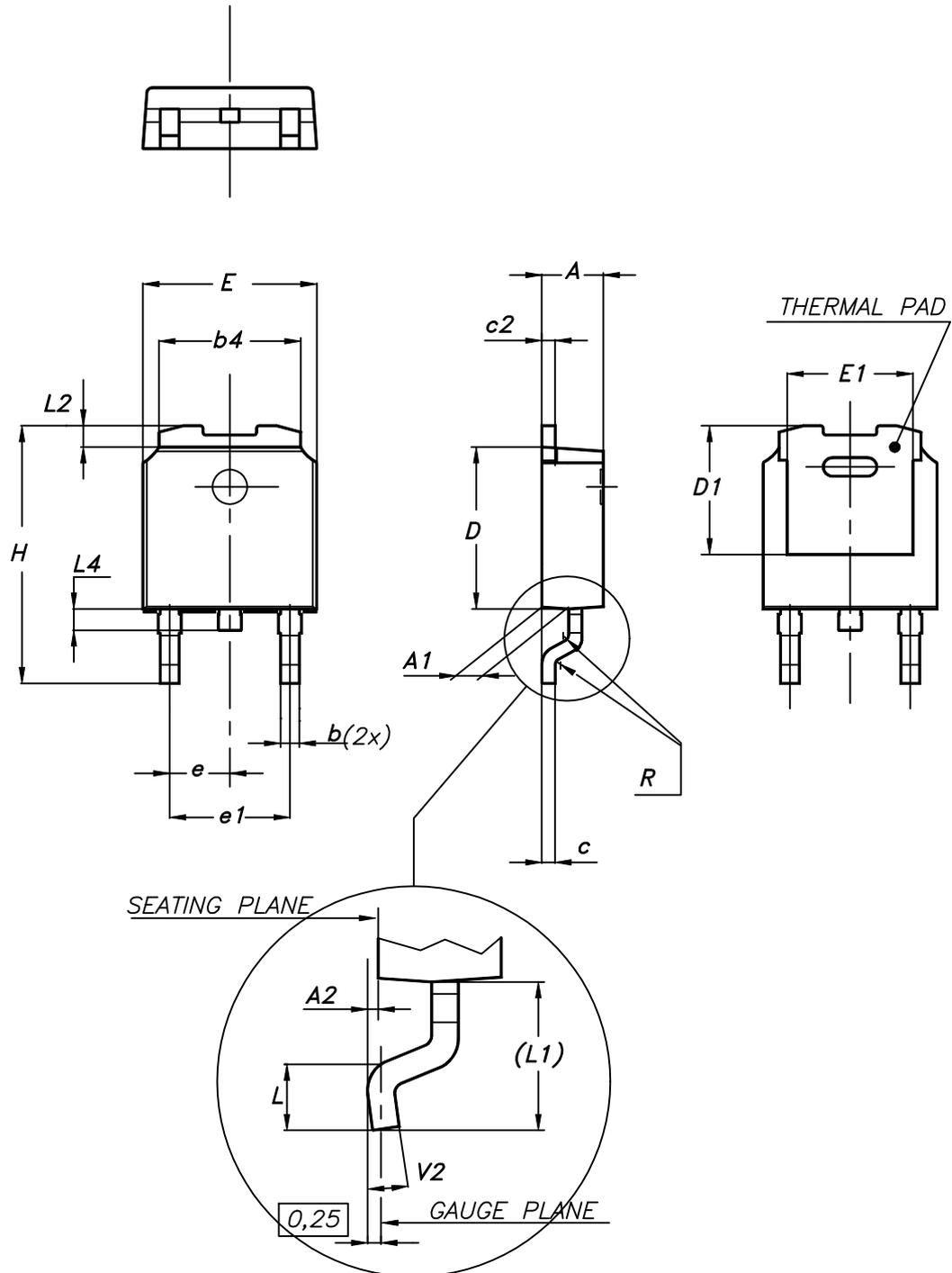
## 4 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 DPAK (TO-252) type A2 package information

Figure 21. DPAK (TO-252) type A2 package outline



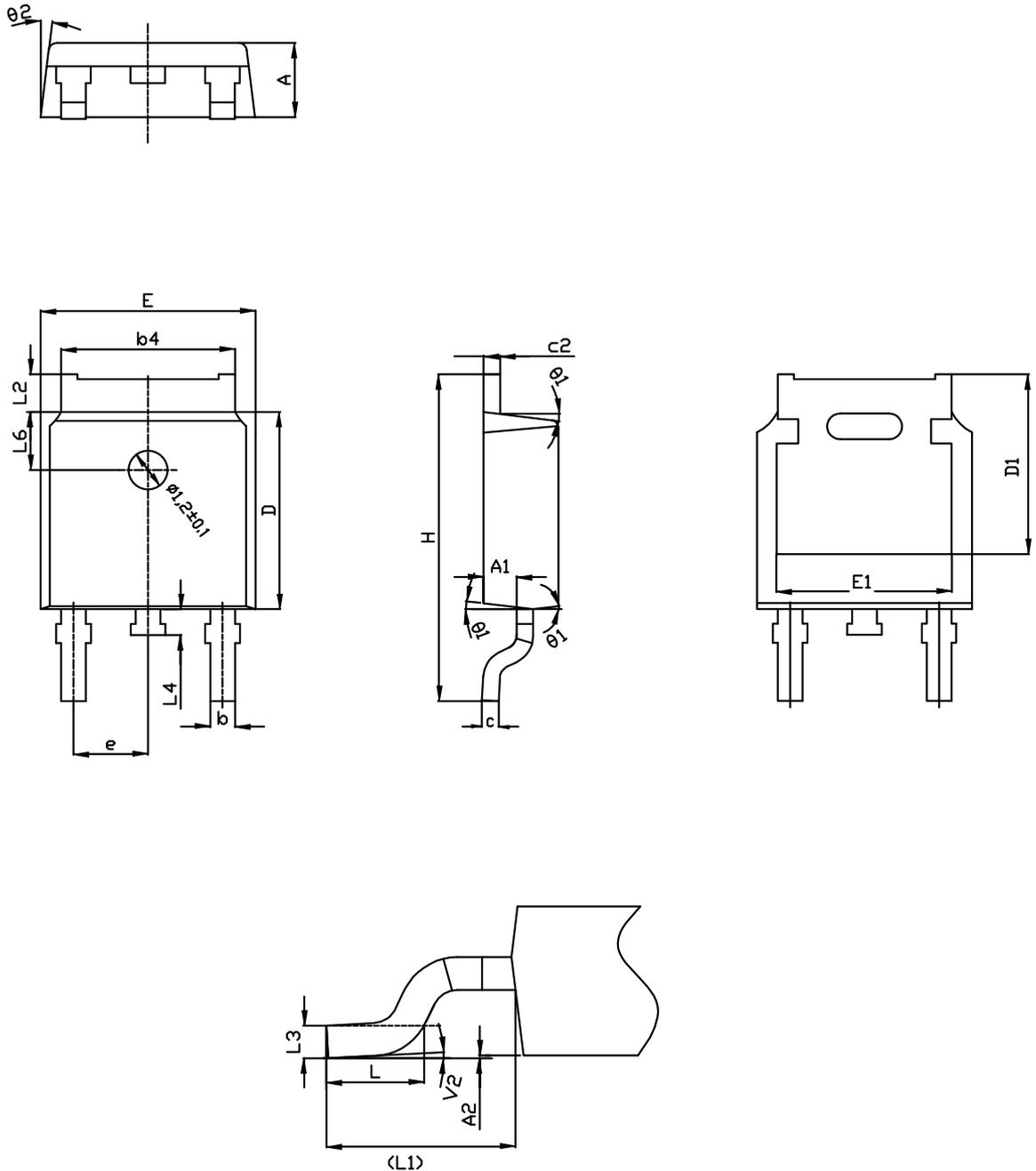
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**Table 9. DPAK (TO-252) type A2 mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
e	2.159	2.286	2.413
e1	4.445	4.572	4.699
H	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

## 4.2 DPAK (TO-252) type C2 package information

Figure 22. DPAK (TO-252) type C2 package outline

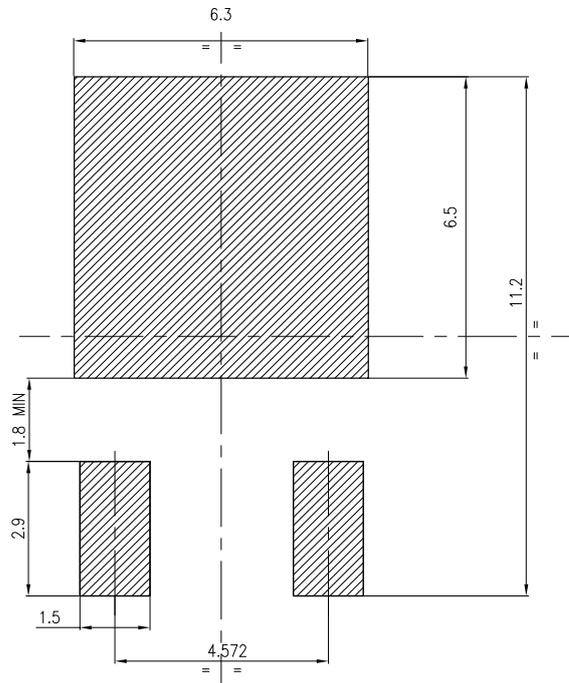


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**Table 10. DPAK (TO-252) type C2 mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	2.20	2.30	2.38
A1	0.90	1.01	1.10
A2	0.00		0.10
b	0.72		0.85
b4	5.13	5.33	5.46
c	0.47		0.60
c2	0.47		0.60
D	6.00	6.10	6.20
D1	5.10		5.60
E	6.50	6.60	6.70
E1	5.20		5.50
e	2.186	2.286	2.386
H	9.80	10.10	10.40
L	1.40	1.50	1.70
L1	2.90 REF		
L2	0.90		1.25
L3	0.51 BSC		
L4	0.60	0.80	1.00
L6	1.80 BSC		
θ1	5°	7°	9°
θ2	5°	7°	9°
V2	0°		8°

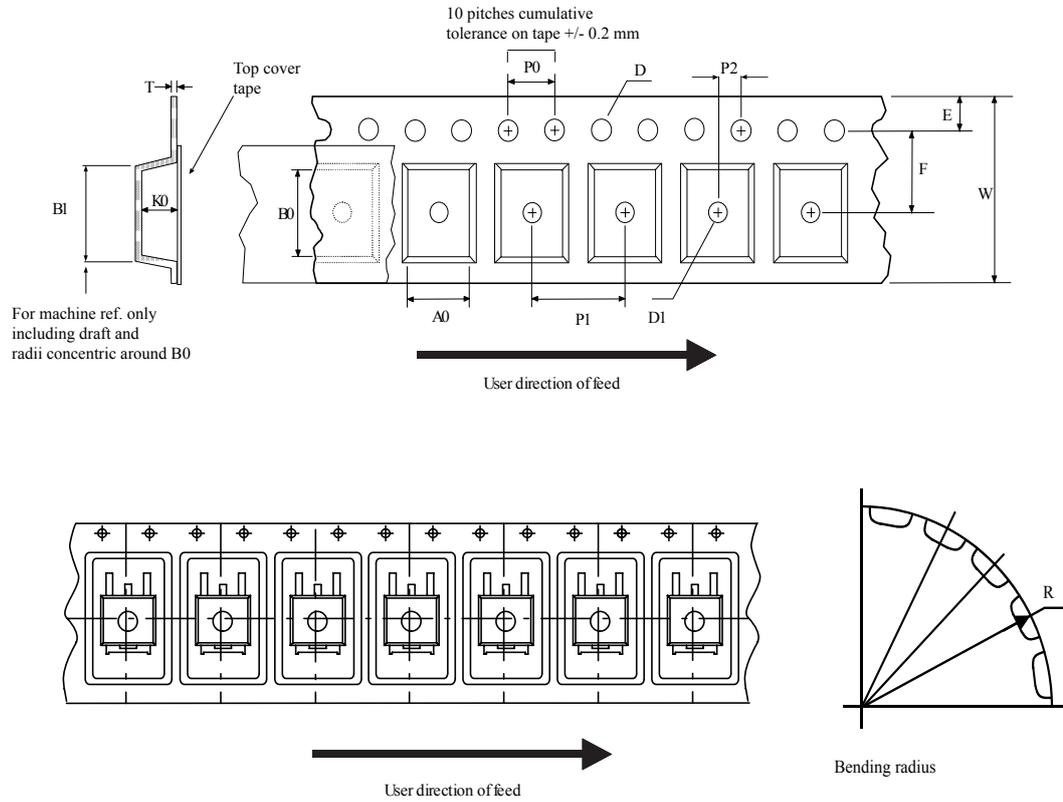
Figure 23. DPAK (TO-252) recommended footprint (dimensions are in mm)



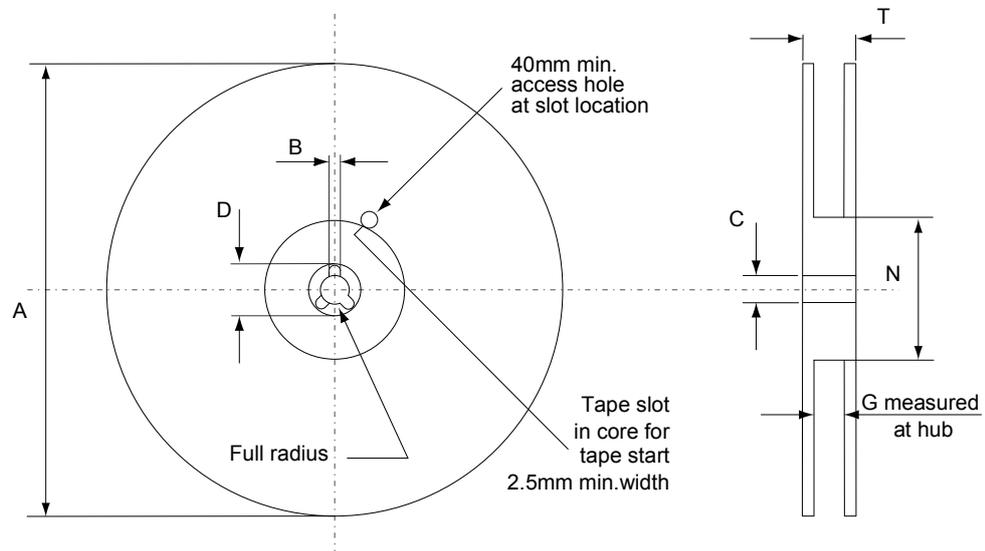
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### 4.3 DPAK (TO-252) packing information

Figure 24. DPAK (TO-252) tape outline



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**Figure 25. DPAK (TO-252) reel outline**


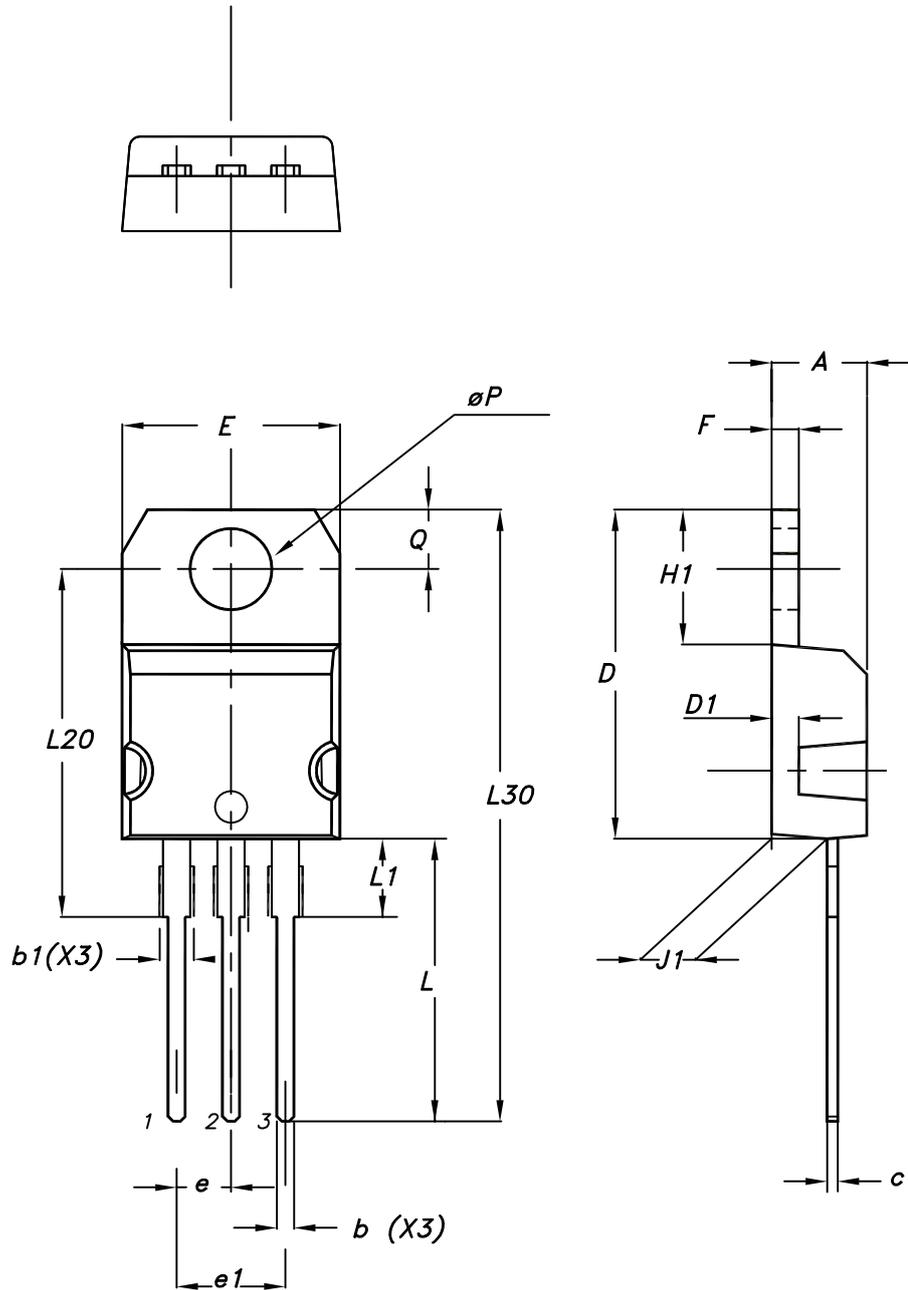
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**Table 11. DPAK (TO-252) tape and reel mechanical data**

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	B	1.5	
B1		12.1	C	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	T		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base qty.		2500
P1	7.9	8.1	Bulk qty.		2500
P2	1.9	2.1			
R	40				
T	0.25	0.35			
W	15.7	16.3			

#### 4.4 TO-220 type A package information

Figure 26. TO-220 type A package outline



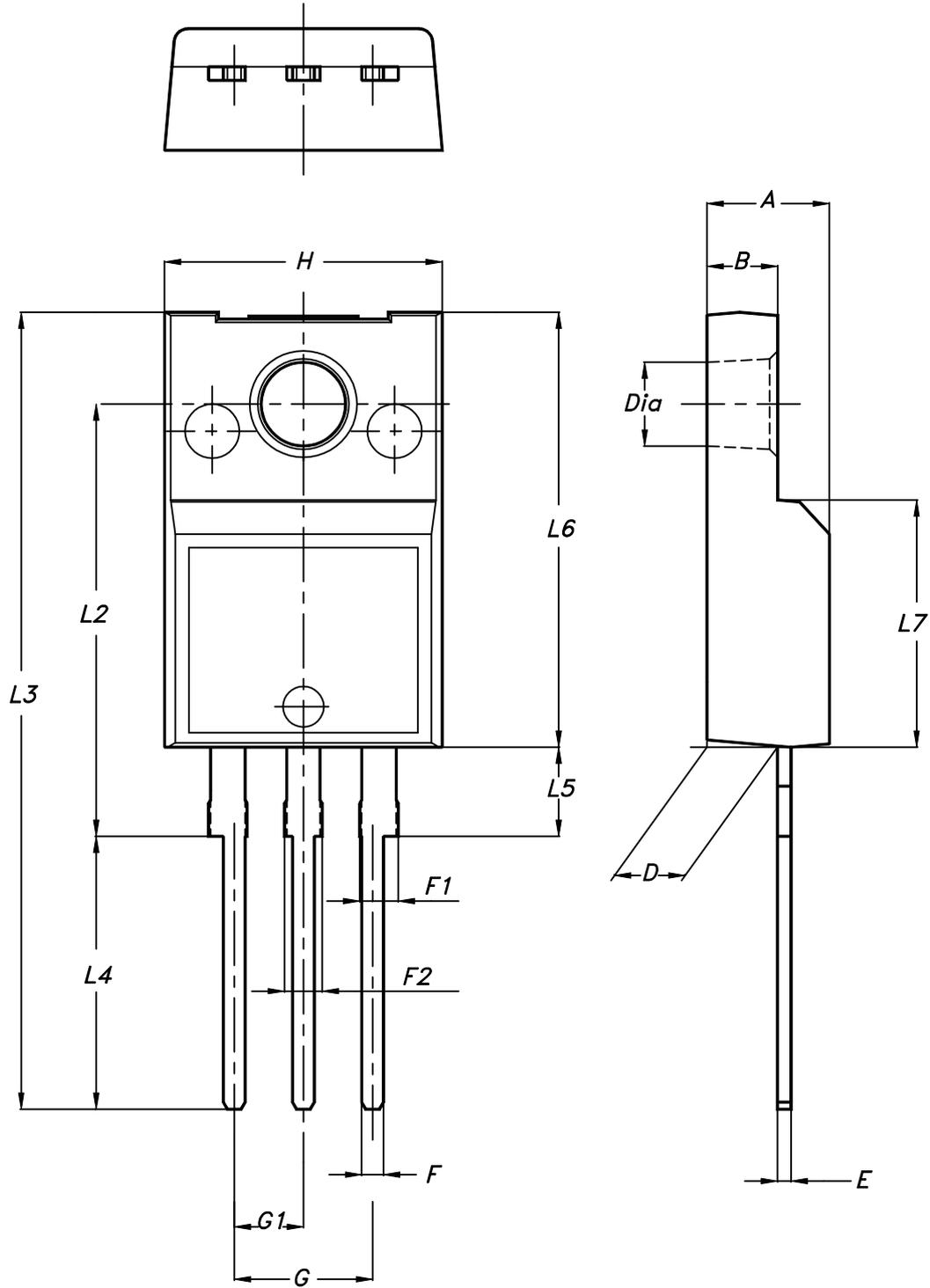
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**Table 12. TO-220 type A package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øP	3.75		3.85
Q	2.65		2.95

### 4.5 TO-220FP package information

Figure 27. TO-220FP package outline



7012510\_Rev\_12\_B

**Table 13. TO-220FP package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	4.4		4.6
B	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
H	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

## 5 Ordering information

Table 14. Order codes

Order code	Marking	Package	Packing
STD3NK90ZT4	D3NK90Z	DPAK	Tape and reel
STP3NK90Z	P3NK90Z	TO-220	Tube
STP3NK90ZFP	P3NK90ZFP	TO-220FP	

## Revision history

**Table 15. Document revision history**

Date	Version	Changes
24-Oct-2006	1	First release.
29-Jan-2013	2	<ul style="list-style-type: none"> <li>– The part number STD3NK90Z-1 has been moved to a separate datasheet</li> <li>– Minor text changes</li> <li>– Updated: Section 4: Package mechanical data</li> </ul>
20-Aug-2018	3	<p>Removed maturity status indication from cover page. The document status is production data.</p> <p>Updated title in cover page, <a href="#">Section 1 Electrical ratings</a>, <a href="#">Section 2 Electrical characteristics</a> and <a href="#">Section 4 Package information</a>.</p> <p>Minor text changes.</p>

## Contents

<b>1</b>	<b>Electrical ratings</b> .....	<b>2</b>
<b>2</b>	<b>Electrical characteristics</b> .....	<b>3</b>
<b>2.1</b>	Electrical characteristics curves .....	5
<b>3</b>	<b>Test circuits</b> .....	<b>8</b>
<b>4</b>	<b>Package information</b> .....	<b>9</b>
<b>4.1</b>	DPAK (TO-252) type A2 package information .....	9
<b>4.2</b>	DPAK (TO-252) type C2 package information .....	11
<b>4.3</b>	DPAK (TO-252) packing information .....	14
<b>4.4</b>	TO-220 type A package information .....	16
<b>4.5</b>	TO-220FP package information .....	18
<b>5</b>	<b>Ordering information</b> .....	<b>21</b>
	<b>Revision history</b> .....	<b>22</b>

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